

STARPOWER

SEMICONDUCTOR

IGBT

GD300HFX170C2SA

1700V/300A 2 in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

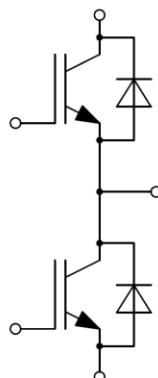
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- 10 μ s short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_C=25^{\circ}\text{C}$ unless otherwise noted**IGBT**

Symbol	Description	Values	Unit
V_{CES}	Collector-Emitter Voltage	1700	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C=25^{\circ}\text{C}$	493	A
	@ $T_C=100^{\circ}\text{C}$	300	A
I_{CM}	Pulsed Collector Current $t_p=1\text{ms}$	600	A
P_D	Maximum Power Dissipation @ $T_{vj}=175^{\circ}\text{C}$	1829	W

Diode

Symbol	Description	Values	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1700	V
I_F	Diode Continuous Forward Current	300	A
I_{FM}	Diode Maximum Forward Current $t_p=1\text{ms}$	600	A

Module

Symbol	Description	Values	Unit
T_{vjmax}	Maximum Junction Temperature	175	$^{\circ}\text{C}$
T_{vjop}	Operating Junction Temperature	-40 to +150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
V_{ISO}	Isolation Voltage RMS, $f=50\text{Hz}$, $t=1\text{min}$	4000	V

IGBT Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=300\text{A}, V_{GE}=15\text{V}, T_{vj}=25^{\circ}\text{C}$		1.85	2.30	V
		$I_C=300\text{A}, V_{GE}=15\text{V}, T_{vj}=125^{\circ}\text{C}$		2.25		
		$I_C=300\text{A}, V_{GE}=15\text{V}, T_{vj}=150^{\circ}\text{C}$		2.35		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=12.0\text{mA}, V_{CE}=V_{GE}, T_{vj}=25^{\circ}\text{C}$	5.6	6.2	6.8	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			1.0	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			400	nA
R_{Gint}	Internal Gate Resistance			2.5		Ω
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$		36.1		nF
C_{res}	Reverse Transfer Capacitance			0.88		nF
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		2.83		μC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=300\text{A}, R_G=2.4\Omega, L_s=42\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=25^{\circ}\text{C}$		355		ns
t_r	Rise Time			71		ns
$t_{d(off)}$	Turn-Off Delay Time			473		ns
t_f	Fall Time			337		ns
E_{on}	Turn-On Switching Loss			89.3		mJ
E_{off}	Turn-Off Switching Loss			46.3		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=300\text{A}, R_G=2.4\Omega, L_s=42\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=125^{\circ}\text{C}$		383		ns
t_r	Rise Time			83		ns
$t_{d(off)}$	Turn-Off Delay Time			549		ns
t_f	Fall Time			530		ns
E_{on}	Turn-On Switching Loss			126		mJ
E_{off}	Turn-Off Switching Loss			68.5		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=900\text{V}, I_C=300\text{A}, R_G=2.4\Omega, L_s=42\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=150^{\circ}\text{C}$		389		ns
t_r	Rise Time			88		ns
$t_{d(off)}$	Turn-Off Delay Time			575		ns
t_f	Fall Time			585		ns
E_{on}	Turn-On Switching Loss			139		mJ
E_{off}	Turn-Off Switching Loss			73.4		mJ
I_{SC}	SC Data	$t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_{vj}=150^{\circ}\text{C}, V_{CC}=1000\text{V}, V_{CEM} \leq 1700\text{V}$		1200		A

Diode Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_F	Diode Forward Voltage	$I_F=300\text{A}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$		1.80	2.25	V
		$I_F=300\text{A}, V_{GE}=0\text{V}, T_{vj}=125^{\circ}\text{C}$		1.95		
		$I_F=300\text{A}, V_{GE}=0\text{V}, T_{vj}=150^{\circ}\text{C}$		1.90		
Q_r	Recovered Charge	$V_R=900\text{V}, I_F=300\text{A},$ $-di/dt=3247\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $L_s=42\text{nH}, T_{vj}=25^{\circ}\text{C}$		68		μC
I_{RM}	Peak Reverse Recovery Current			202		A
E_{rec}	Reverse Recovery Energy			34.5		mJ
Q_r	Recovered Charge	$V_R=900\text{V}, I_F=300\text{A},$ $-di/dt=2579\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $L_s=42\text{nH}, T_{vj}=125^{\circ}\text{C}$		114		μC
I_{RM}	Peak Reverse Recovery Current			211		A
E_{rec}	Reverse Recovery Energy			61.2		mJ
Q_r	Recovered Charge	$V_R=900\text{V}, I_F=300\text{A},$ $-di/dt=2395\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$ $L_s=42\text{nH}, T_{vj}=150^{\circ}\text{C}$		136		μC
I_{RM}	Peak Reverse Recovery Current			217		A
E_{rec}	Reverse Recovery Energy			73.9		mJ

Module Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance			20	nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		0.35		m Ω
R_{thJC}	Junction-to-Case (per IGBT)			0.082	K/W
	Junction-to-Case (per Diode)			0.127	
R_{thCH}	Case-to-Heatsink (per IGBT)		0.033		K/W
	Case-to-Heatsink (per Diode)		0.051		
	Case-to-Heatsink (per Module)		0.010		
M	Terminal Connection Torque, Screw M6	2.5		5.0	N.m
	Mounting Torque, Screw M6	3.0		5.0	
G	Weight of Module		300		g

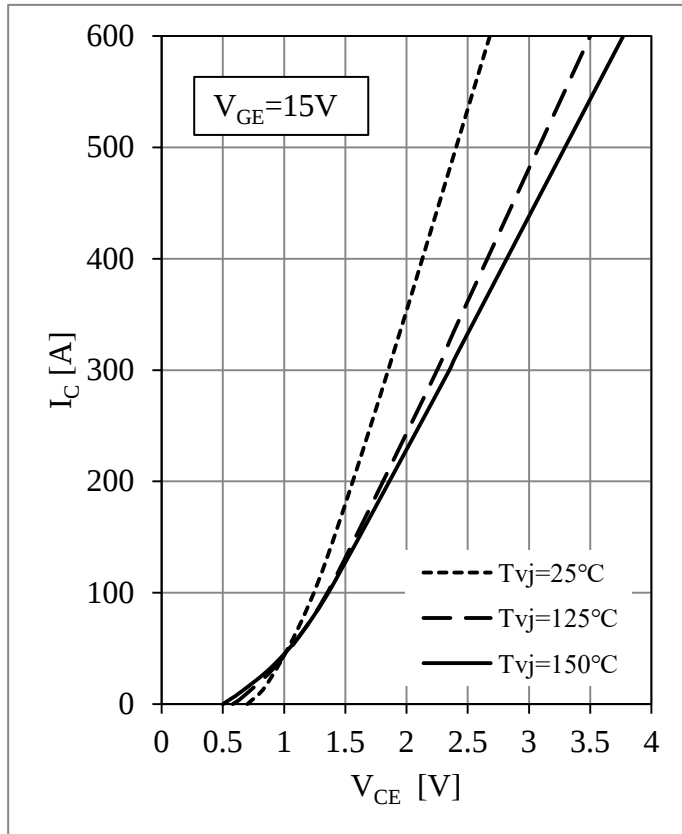


Fig 1. IGBT Output Characteristics

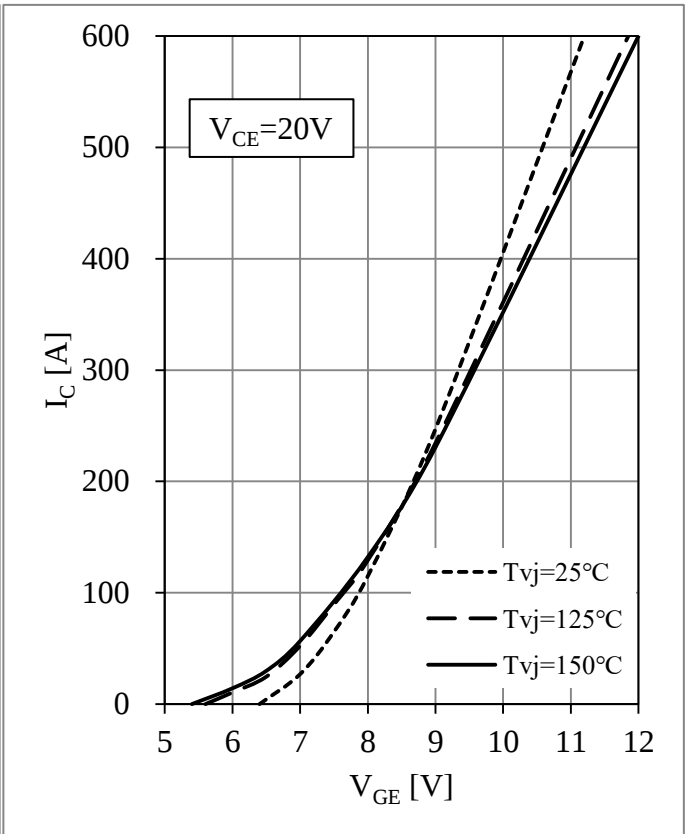
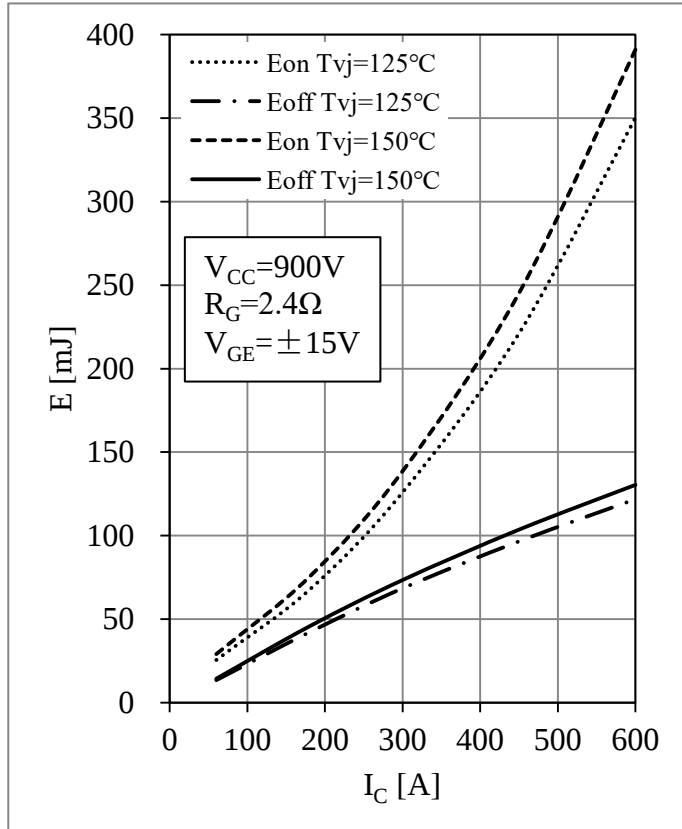
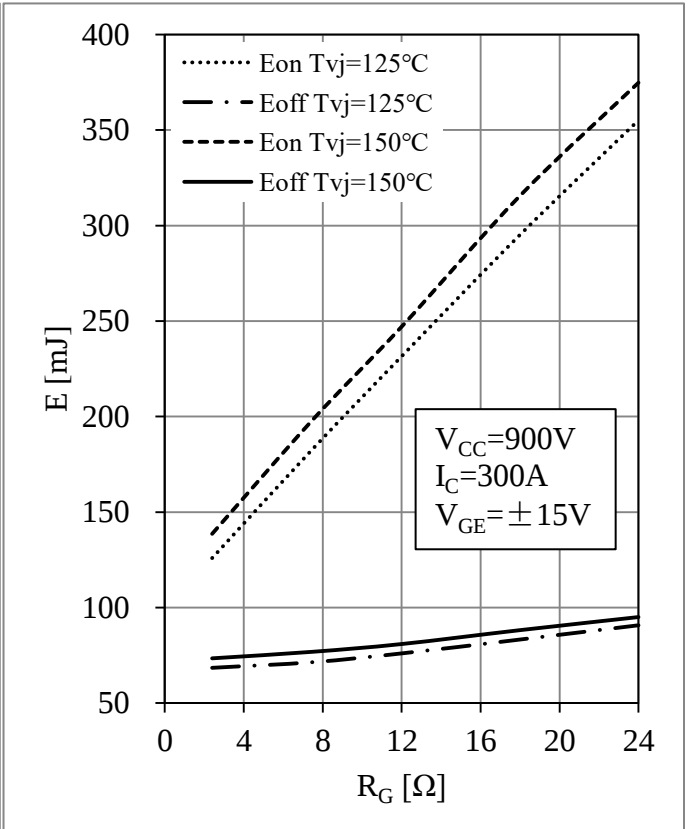


Fig 2. IGBT Transfer Characteristics

Fig 3. IGBT Switching Loss vs. I_C Fig 4. IGBT Switching Loss vs. R_G

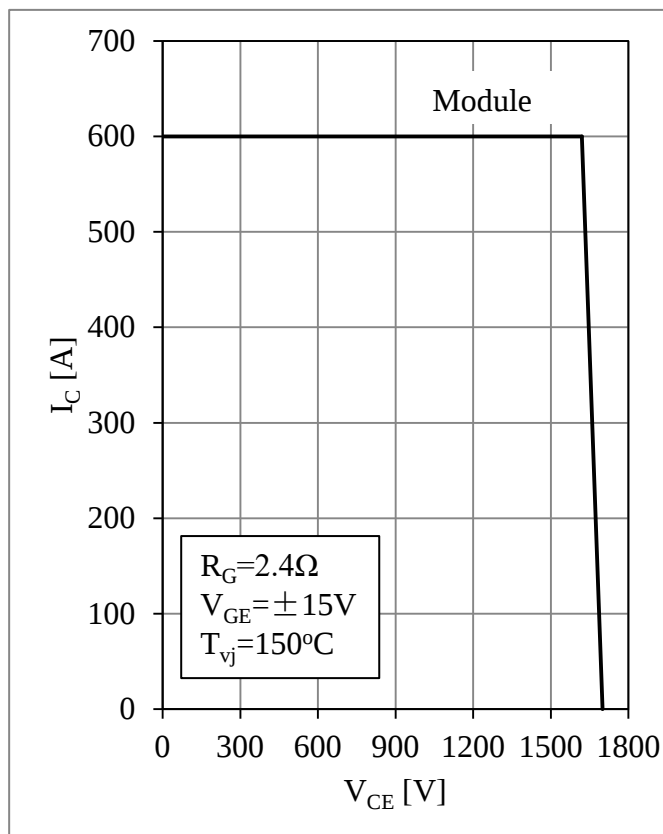


Fig 5. RBSOA

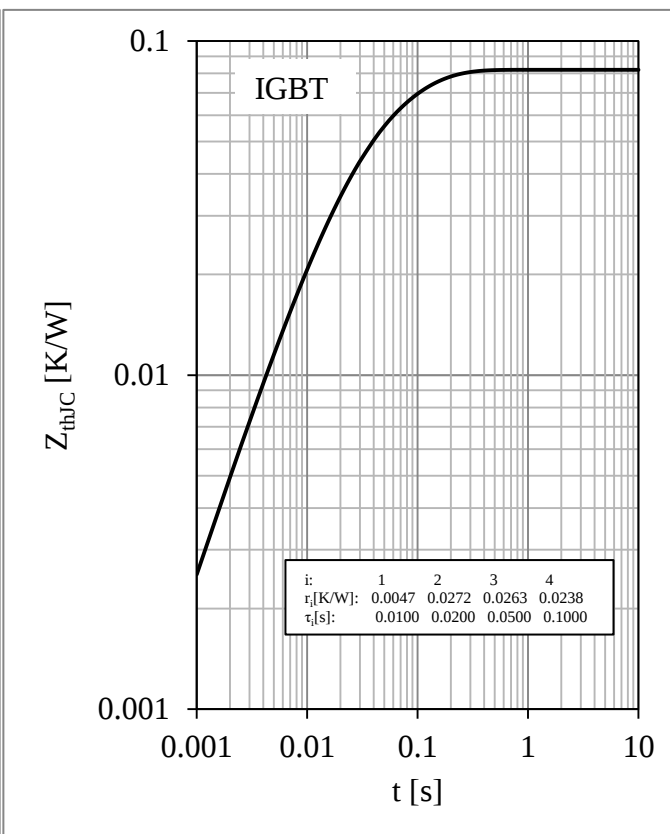


Fig 6. IGBT Transient Thermal Impedance

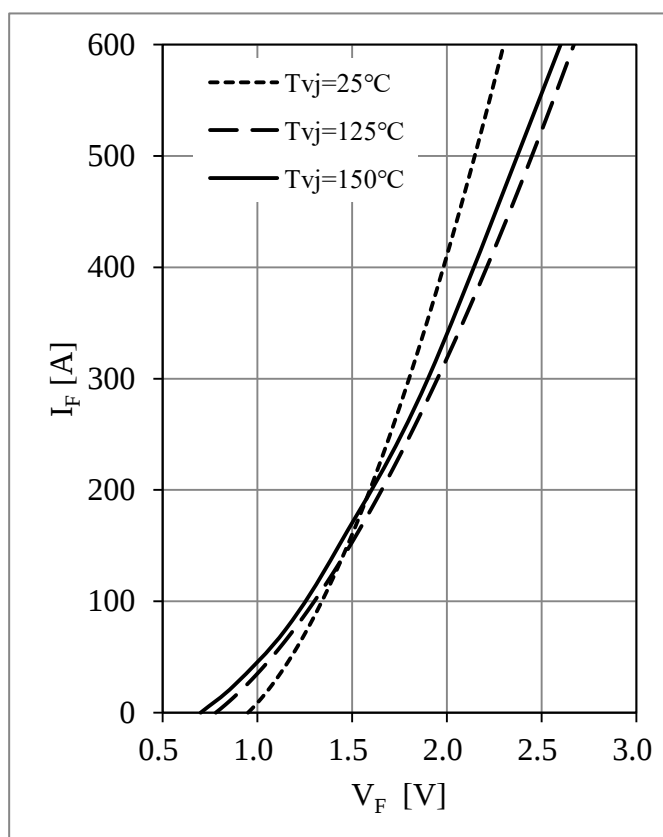
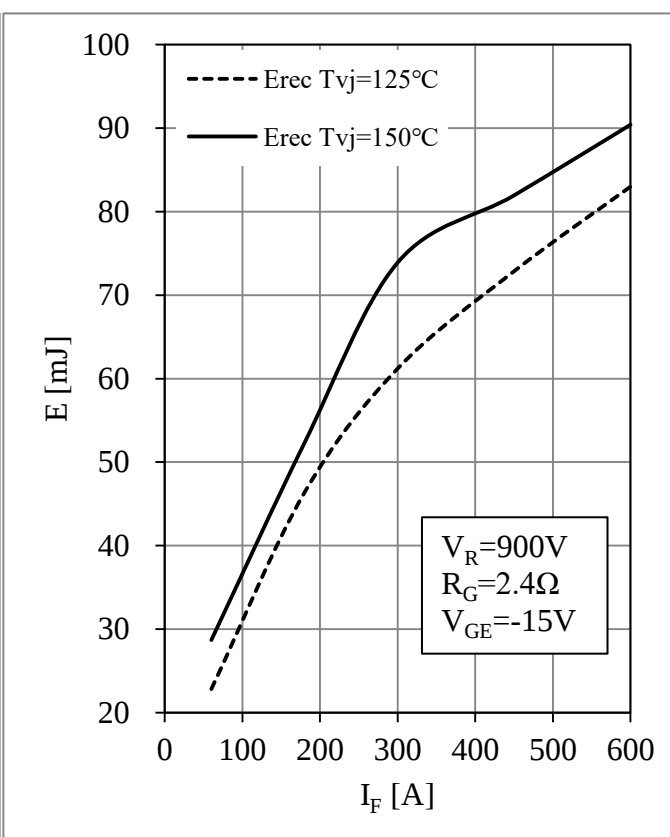


Fig 7. Diode Forward Characteristics

Fig 8. Diode Switching Loss vs. I_F

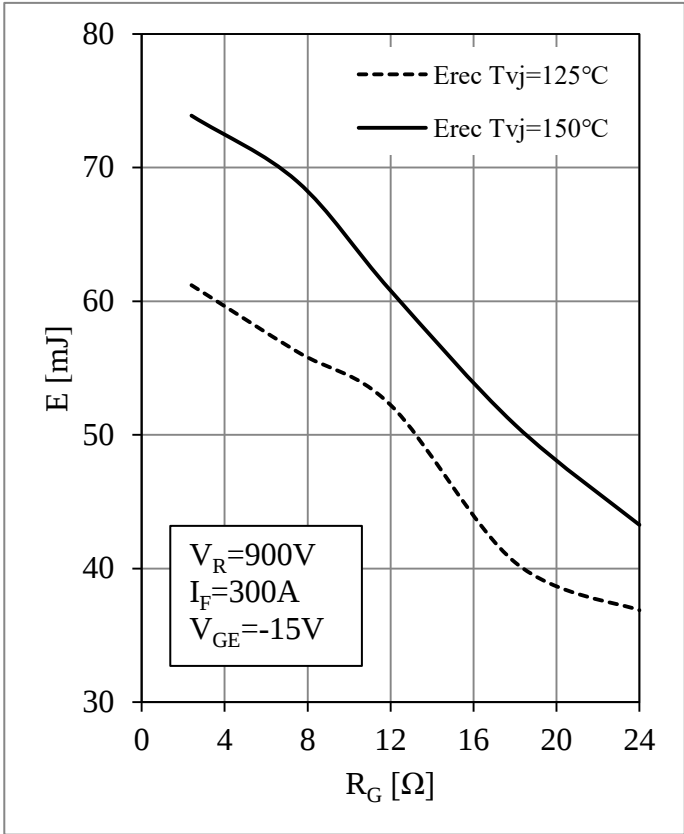


Fig 9. Diode Switching Loss vs. R_G

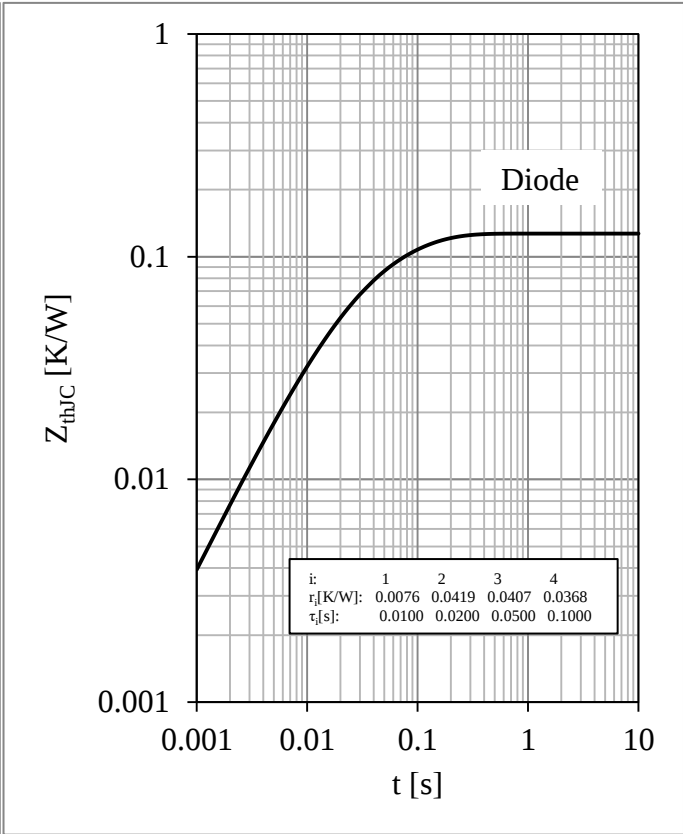
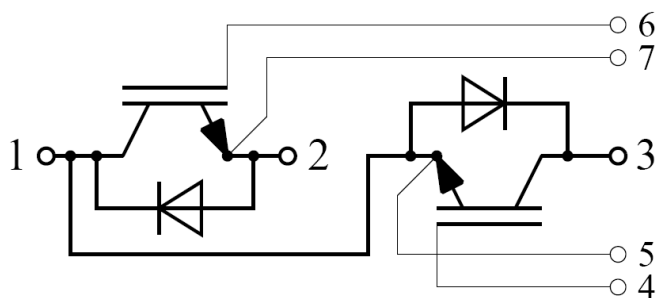


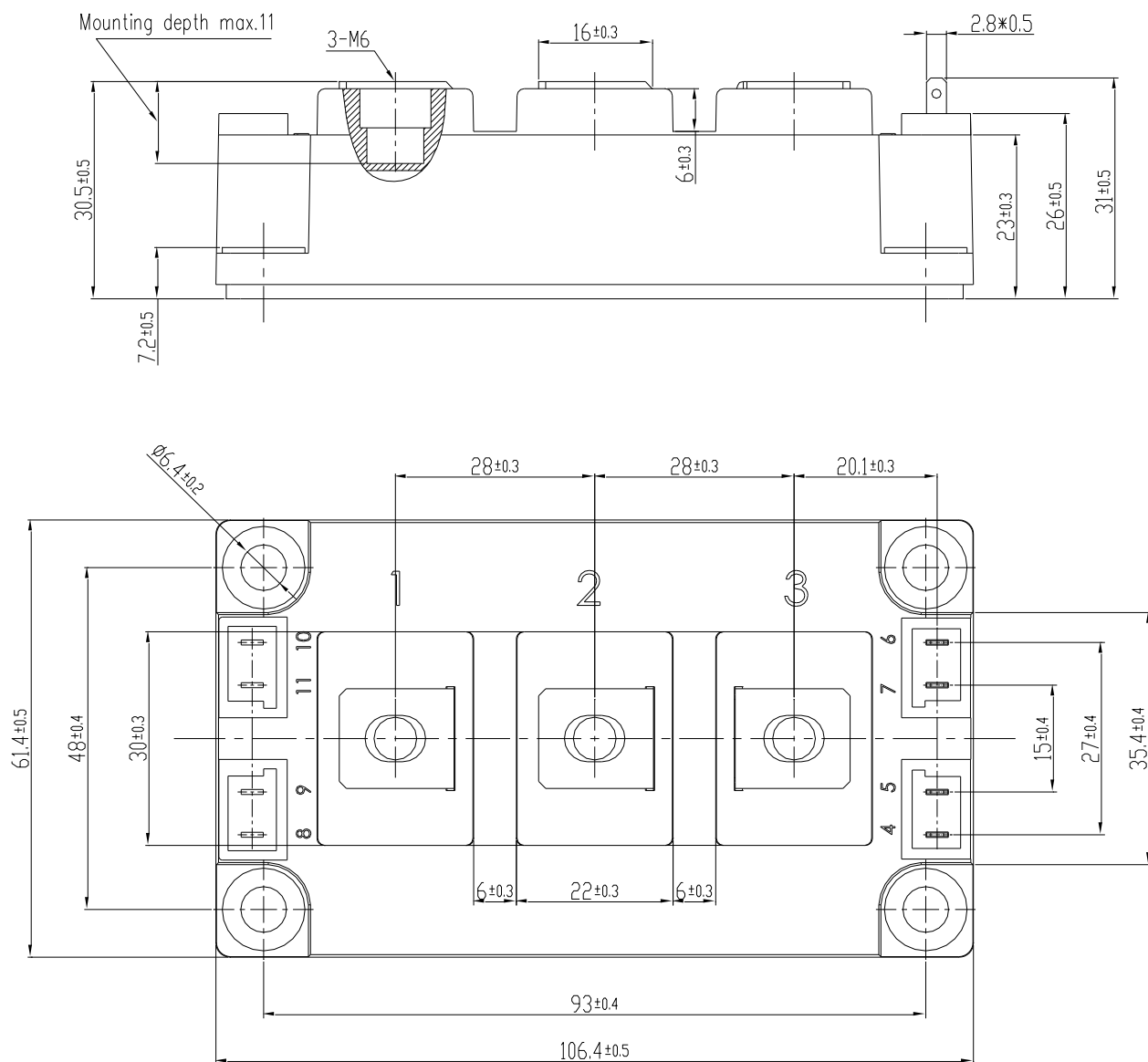
Fig 10. Diode Transient Thermal Impedance

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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